DZ2J039

Silicon epitaxial planar type

For constant voltage / waveform clipper and surge absorption circuit Low noise type

■ Features

- Excellent rising characteristics of zener current Iz
- Eco-friendly Halogen-free package

■ Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Repetitive peak forward current	I_{FRM}	200	mA
Total power dissipation *	P _T	200	mW
Junction temperature	T _j	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

Note) *: P_T = 200 mW achieved with a printed circuit board.

■ Package

- Code SMini2-F5-B
- Pin Name
 - 1. Cathode
 - 2. Anode
- Marking Symbol: 7J, 7U

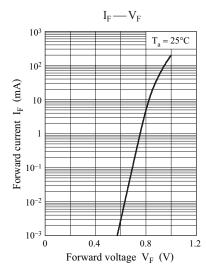
■ Electrical Characteristics $T_a = 25$ °C±3°C

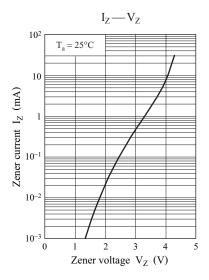
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V_{F}	$I_F = 10 \text{ mA}$			1.0	V
Zener voltage *1,2,4	V _Z	$I_Z = 5 \text{ mA}$	3.71		4.10	V
Zener operating resistance	R_Z	$I_Z = 5 \text{ mA}$			130	Ω
Reverse current	I_R	$V_R = 1 V$			10	μΑ
Temperature coefficient of zener voltage *3	S_Z	$I_Z = 5 \text{ mA}$		-1.3		mV/°C

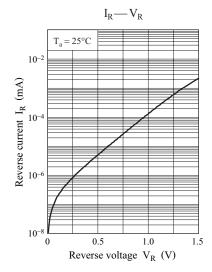
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. Absolute frequency of input and output is 5 MHz.
 - 3. *1: The temperature must be controlled 25°C for V_Z measurement. V_Z value measured at other temperature must be adjusted to V_Z (25°C)
 - *2: V_Z guaranteed 20 ms after current flow.
 - *3: $T_i = 25^{\circ}C$ to $150^{\circ}C$
 - *4: Rank classification

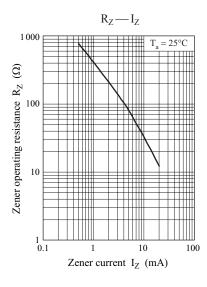
Code	M	0	
Rank	M	No-rank	
V_Z	3.80 to 4.00	3.71 to 4.10	
Marking Symbol	7 U	7J	

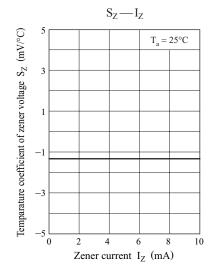
DZ2J039 Panasonic

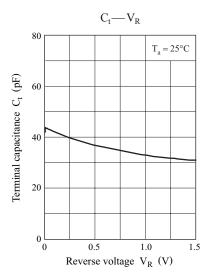








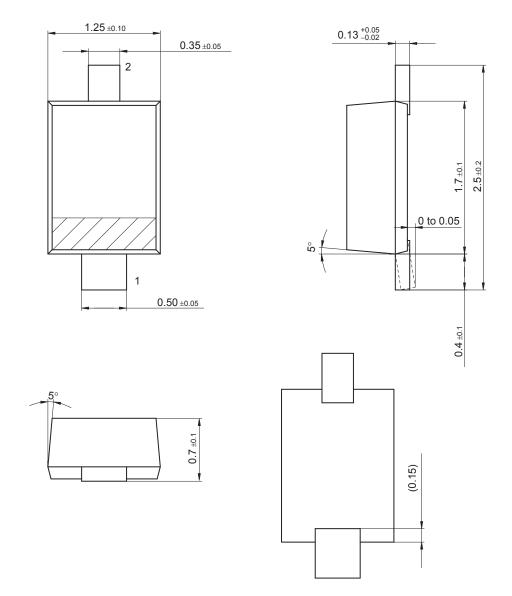




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SMini2-F5-B

Unit: mm



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